



# **Product Change Notification**

## **113923 - 00**

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# Product Change Notification

**Change Notification #:** 113923 - 00  
**Change Title:** Intel® NUC Kit DC3217IYE, 5 Pack,  
Intel® NUC Kit DC53427HY, 5 Pack,  
Intel® NUC Kit DC53427HY, 10 Pack,  
PCN 113923-00, Label,  
Label update  
**Date of Publication:** June 29, 2015

## Key Characteristics of the Change:

Label

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	Jul 27, 2015
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## Description of Change to the Customer:

The Intel® NUC Kit listed in the product affected table below will have the following change.

Add BIS certificate label on the FSP adapter to support the India shipment.

Example pictures:





Note: Due to current insufficient space for BIS logo for adapter label, proposal is to use BIS logo instead FCC logo on adapter label and will use a small label to place on the flank of adapter.

### **Customer Impact of Change and Recommended Action:**

There is not impact to the Form, Fit, or Function of operation of the Product. The change is only for labeling which affects the visual appearance.

Customers should be aware of the changes to the label and take appropriate actions to accommodate the changes and avoid impact to their process.

Milestone dates are estimates and subject to change based on business and operational conditions.

### **Products Affected / Intel Ordering Codes:**

<b>Product Code</b>	<b>MM#</b>	<b>Pre Change SA</b>	<b>Post Change SA</b>
BOXDC3217IYE	924222	G80097-109	G80097-110
BOXDC53427HYE	927920	H10106-106	H10106-107
BLKDC53427HYE	930170	G87963-107	G87963-108

### **PCN Revision History:**

**Date of Revision:**

June 29, 2015

**Revision Number:**

00

**Reason:**

Originally Published PCN